AMINED BY:		FILE NO . CAS-0008933
C.H. Clin	EMERGING DISPLAY	ISSUE : FEB.06, 2020
PROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 22
Yung Chang Hu		VERSION: 2
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
	ODEL NO.:  ETEMB043013XDHA  (RoHS)  R MESSRS:	L and the state of

# MODEL NO. VERSION PAGE EMERGING DISPLAY TECHNOLOGIES CORPORATION ETEMB043013XDHAL 2 0 - 1DOC . FIRST ISSUE DEC.26, 2019 R E C O R D SOF REVISION REVISED DATE **PAGE** SUMMARY NO. FEB.06, 2020 11.1 CN1 POWER SUPPLY INTERFACE 11 PIN NO. SYMBOL FUNCTION POWER SUPPLY (7~36V) VP IN VP IN POWER SUPPLY (7~36V) POWER SUPPLY ENABLE (INTERNAL PULL HIGH) VP EN NC NOT CONNECT VSS GROUND VSS GROUND Display is the without althoritation of the control SYMBOL PIN NO. FUNCTION POWER SUPPLY VP\_IN

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- 1. GENERAL SPECIFICATIONS
- 1.1 DATA SHEETS FOR EMBEDDED SYSTEM MCU DRIVER PLEASE REFER TO:

### STM32F750

1.2 DATA SHEET FOR CAPACITIVE TOUCH PANEL CONTROLLER/ DRIVER PLEASE REFER TO:

### ILI 2511

- 1.3 MATERIAL SAFETY DESCRIPTION
  ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
  INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
  MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
  BIPHENYLS (PBB) AND POLYBROMINATED
  DIPHENYL ETHERS (PBDE), BIS(2-ETHYLHEXYL) PHTHALATE (DEHP), BUTYL
  BENZYL PHTHALATE (BBP), DIBUTYL PHTHALATE (DBP), DIISOBUTYL
  PHTHALATE (DIBP).
- 2. MECHANICAL SPECIFICATIONS
  - 2.1 EMBEDDED SYSTEM MECHANICAL SPECIFICATIONS

(1) DISPLAY SIZE	4.3 inch
(2) NUMBER OF DOTS	480W * (RGB) * 272H DOTS
(3) MODULE SIZE	130.04W * 88.86H *13.1D(MAX.) mm
(4) VIEWING AREA	96.04W * 54.86H mm
(5) ACTIVE AREA	95.04W * 53.856H mm
(6) DOT SIZE	0.066W * 0.198H mm
(7) PIXEL SIZE	0.198W * 0.198H mm
(8) LCD TYPE	IPS-TFT , TRANSMISSIVE, NORMALLY
(9) COLOR	BLACK 16.7M
(9) COLOR	10./1/1
(10) VIEWING DIRECTION	SUPER WIDE VIEW
(11)BACK LIGHT	LED , COLOR : WHITE
( 12 ) INTERFACE MODE	SPI , I2C , RS232 , RS485 , CAN , GPIO
	USB

APACITIVE TOUCH PANEL MECHANICAL SPECIFICATIONS  WODEL NO.  ETEMB043013XDHAL  2  APACITIVE TOUCH PANEL MECHANICAL SPECIFICATIONS	2
(1) TOLICH DANEL GIZE	
(1) TOUCH PANEL SIZE4.3 inch	
( 2 ) OUTER DIMENSION 130.04W * 88.86H mm	
(3) ACTIVE AREA96.04W * 54.86H mm	
(4) INPUT TYPE MULTI TOUCH *	
(5) NUMBER OF TOUCH SENSOR	
*NOTE: ACCORDING TO IMPLEMENTATION DESIGN	
NOTE. ACCORDING TO IMI LEMENTATION DESIGN	
	•
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### 3. ABSOLUTE MAXIMUM RATINGS

### 3.1 EMBEDDED SYSTEM ELECTRICAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER VOLTAGE	VP_IN	-0.3	+40	V	VSS=0
INPUT VOLTAGE	VIN	-0.3	4.0	V	

### 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	OPERATING		STORAGE		REMARK	
HEWI	MIN.	MAX.	MIN.	MAX.	KEWIAKK	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1), (2)	
HUMIDITY	NOTI	E(3)	NOTE(3)		WITHOUT CONDENSATION	
VIBRATION		2.45 m/s <sup>2</sup> ( 0.25 G)	_	11.76 m/s <sup>2</sup> (1.2 G)	10~100Hz XYZ DIRECTIONS 1 HR EACH	
SHOCK	<b>Y</b> – ,	29.4 m/s <sup>2</sup> ( 3 G)	:105	490 m/s <sup>2</sup> ( 50 G )	10ms XYZ DIRECTIONS 1 TIME EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACCEPTABLE			

NOTE (1): Ta AT  $-30^{\circ}$ C: 48HRS MAX.

80°C: 168HRS MAX.

NOTE ( 2 ) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE

THIS PHENOMENON IS REVERSIBLE.

NOTE (3):  $Ta \le 60$ °C: 90%RH MAX (96HRS MAX).

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY OF 90%RH AT 60°C(96HRS MAX).

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### 4. ELECTRICAL CHARACTERISTICS

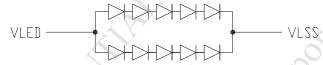
### 4.1 EMBEDDED SYSTEM ELECTRICAL CHARACTERISTICS

Ta = 25 °C

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VP_IN		7	12	36	V	VGND=0
POWER SUPPLY CURRENT	$I_{VP\_IN}$	VP_IN=7V	_	280	340	mA	
	Ivp_in	VP_IN=12V	_	170	205	mA	4 -
CORRENT	Ivp_in	VP_IN=36V	_	65	80	mA	4
LED LIFE TIME		_	30K			HRS	NOTE (4) NOTE (5)

NOTE (1): VIL/VIH/VOL/VOH REFER TO STM32F750 DATA SHEET

NOTE (2): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE ( 3 ) : MAXIMUM ALLOWED CURRENT IN LEDS VS. TEMPERATURE ARE AUTOMATICALLY ADJUSTED BY SYSTEM CONTROLLER.

NOTE (4): CONDITIONS; Ta=25 °C, CONTINUOUS LIGHTING

NOTE (5): DEFINITIONS OF FAILURE

LCD LUMINANCE BECOMES HALF OF THE INITIAL VALUE.

# 5. TIMING CHARACTERISTICS

REFER TO STM32F750 DATA SHEET

### 6. MCU CHARACTERISTICS

ITEM	MEMO	MEMORY SIZE	
I I EWI	INTERNAL	EXTERNAL	REMARK
SD RAM	320KB	16 MB	
FLASH	64KB	32 MB	

NOTE: THE FLASH MEMORY SIZE CAN BE UP TO 128MB

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# 7. OPTICAL CHARACTERISTICS (NOTE 1)

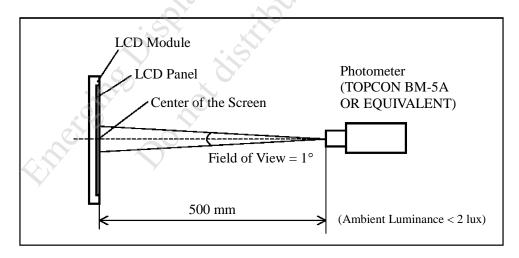
### 7.1 OPTICAL CHARACTERISTICS

 $Ta = 25 \pm 2$  °C

ITEM		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK
		$\theta_{y+}$		0 -00	70	80			
VIEWING ANGLE		$\theta_{ ext{y-}}$	GD > 10	$\theta_{x}=0^{\circ}$	70	80		deg.	NOTE(2)
VIEWING ANGLE		$\theta_{x+}$	CR ≥ 10		70	80			NOTE(3)
		$\theta_{x}$		$\theta_y=0^{\circ}$	70	80			
CONTRAST RATIO (CENTER)	)	CR	θx=0°,	θy=0°	640	800	_	0	NOTE(3)
RESPONSE TIME		$T_R + T_F$	θx=0°,	θу=0°		30	40	msec	NOTE (4)
	WHITE	Wx	1		0.25	0.30	0.35	)	
	WHILE	Wy			0.27	0.32	0.37		<b>~</b> .
G07.07	RED	Rx			0.55	0.60	0.65		O
COLOR CHROMATICITY		RY	θx=0°,	°, θy=0°	0.31	0.36	0.41		NOTE (5)
(CENTER)	GREEN	Gx	NTSC	: 45 %	0.32	0.37	0.42	.15	NOIE (3)
	UKEEN	Gy		6	0.52	0.57	0.62	N. T.	
	BLUE	Bx	. 18		0.10	0.15	0.20	2	
	BLUE	Ву			0.04	0.09	0.14		
THE BRIGHTNESS		В	04-00	θy=0°	380	425	0	cd/m <sup>2</sup>	NOTE (6)
OF MODULE (CENTER)		В	θx-0 ,	Uy_U	360	423		Cu/III	NOIE (0)
THE UNIFORMITY OF MODULE		OM:	θx=0°,	θy=0°	70	75		%	NOTE (7)

### NOTE (1): TEST CONDITION:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM.



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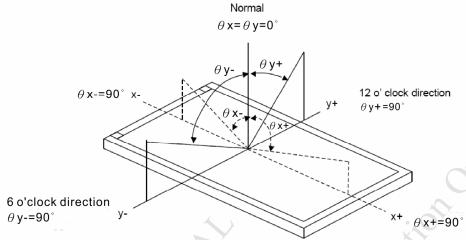
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NOTE (2): DEFINITION OF VIEWING ANGLE:

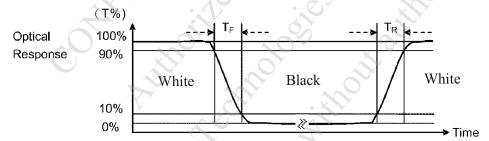


NOTE ( 3 ) : DEFINITION OF CONTRAST RATIO (CR) :

MEASURED AT THE CENTER POINT OF MODULE

CONTRAST RATIO(CR) =  $\frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$ 

NOTE ( 4 ) : DEFINITION OF RESPONSE TIME :  $T_R$  AND  $T_F$  THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



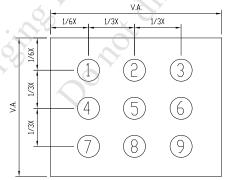
NOTE (5): DEFINITION OF COLOR CHROMATICITY

(a)100% RGB PIXEL DATA TRANSMISSION WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY POWERED ON.

(b) MEASURED AT THE CENTER POINT OF MODULE

NOTE (6): MEASURED THE BRIGHTNESS OF WHITE STATE AT CENTER POINT.

NOTE (7): (a) DEFINITION OF BRIGHTNESS UNIFORMITY



UNIT: mm

(b)THE BRIGHTNESS UNIFORMITY CALCULATING METHOD

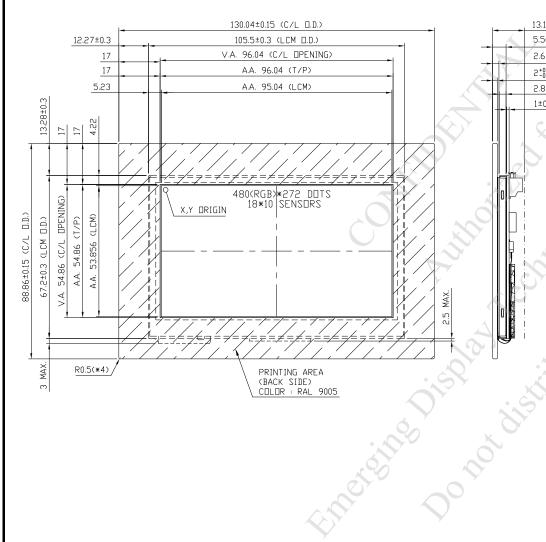
UNIFORMITY: MINIMUM BRIGHTNESS \*100%

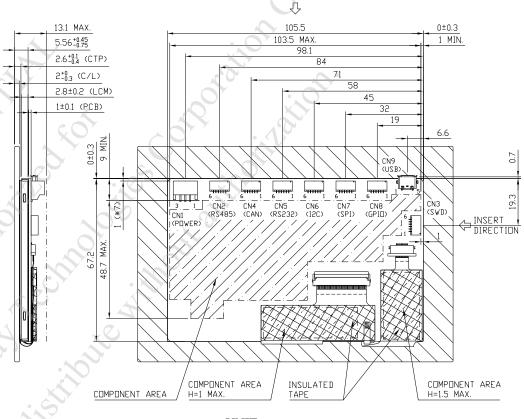
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# 8. OUTLINE DIMENSIONS





INSERT DIRECTION (\*8)

UNIT : mm SCALE : NTS

NOT SPECIFIED TOLERANCE IS  $\pm 0.5$ 

NOTE:

1.C/L GLASS: SODA LIME, CHAMFERED EDGES.

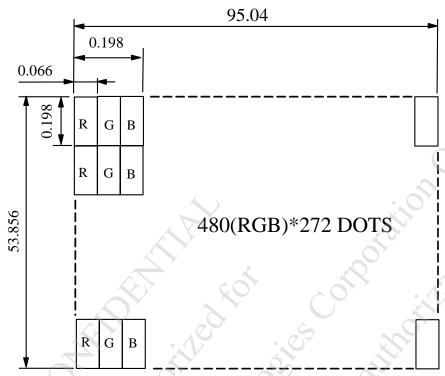
2.CN1: CHIN-TEK 2022-03/SMT

3.CN2~CN8: JST SM06B-SRSS-TB(LF)(SN)

4.CN9: MOLEX 47590-0001

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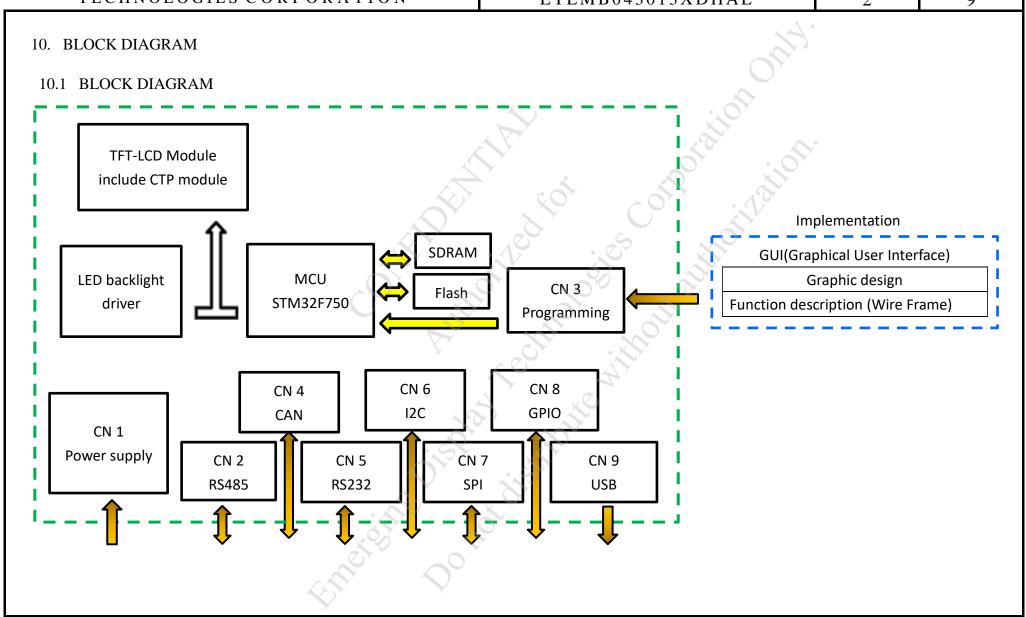
UNIT : mm SCALE : NTS

Zinerojno Jispio i distrife

NOT SPECIFIED TOLERANCE IS  $\pm$  0.1 DOTS MATRIX TOLERANCE IS  $\pm$  0.01

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### 10.2 IMPLEMENTATION TURN-KEY SOLUTION

BUSINESS MODEL	IMPLEMENTATION	GRAPHIC DESIGN	
MODEL 1	EDT	EDT	
MODEL 2	EDT	CUSTOMER / THIRD PARTY	
MODEL 3	CUSTOMER / THIRD PARTY	CUSTOMER / THIRD PARTY	

NOTE: THE MODEL 3 WILL REQUIRE THE SOFTWARE IMPLEMENTATION BY CUSTOMER OR A THIRD PARTY. CUSTOMER OR THIRD PARTY WILL NEED TO PROVIDE A BIN OR HEX FILE TO EDT DURING INITIAL DESIGN/DEVELOPMENT STAGE OF ing Display distribute without authoritation. PROJECT, AND COULD REFERENCE TouchGFX FOR THIS DEVELOPMENT.

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# 11. INTERFACE SIGNALS

# 11.1 CN1 POWER SUPPLY INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	VP_IN	POWER SUPPLY
2	VP_EN	POWER SUPPLY ENABLE (INTERNAL PULL HIGH)
3	VSS	GROUND

### 11.2 CN2 RS485 INTERFACE

PIN NO.	SYMBOL	FU	JNCTION	0
1	VSS	GROUND		<b>3</b> ′
2	VSS	GROUND		Y
3	RS485A	RS485-A		
4	RS485B	RS485-B		
5	VSS	GROUND		400
6	VSS	GROUND		X

# 11.3 CN3 PROGRAMMING INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	3V3	POWER SUPPLY (3.3V OUTPUT)
2	SWO	SWO
3	SWDIO	DATA
4	SWCLK	CLOCK
5	NRST	RESET
6	VSS	GROUND

# 11.4 CN4 CAN INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	VSS Ó	GROUND
2	VSS	GROUND
3	CANL	LOW LEVEL CAN BUS SIGNAL
4	CANH	HIGH LEVEL CAN BUS SIGNAL
5	VSS	GROUND
6	VSS	GROUND

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# 11.5 CN5 RS232 INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	VSS	GROUND
2	RTS	REQUEST TO SEND
3	TX1	TRANSMIT DATA
4	RX1	RECEIVE DATA
5	CTS	CLEAR TO SEND
6	VSS	GROUND

# 11.6 CN6 I2C INTERFACE

PIN NO.	SYMBOL	FUNCT	ION	<b>~</b>
1	3V3	3.3V OUTPUT	•	O
2	I2C_SCL	CLOCK INPUT		
3	I2C_SDA	DATA INPUT AND OUTPUT	200	
4	I2C_INT	INTERRUPT SIGNAL	70	
5	I2C_RST	RESET SIGNAL		100
6	VSS	GROUND	70	• 1

# 11.7 CN7 SPI INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	3V3	3.3V OUTPUT
2	SPI_NSS	CHIP SELECT SIGNAL
3	SPI_SCK	SERIAL CLOCK
4	SPI_MISO	SERIAL DATA OUTPUT
5	SPI_MOSI	SERIAL DATA INPUT
6	VSS	GROUND

# 11.8 CN8 GPIO INTERFACE

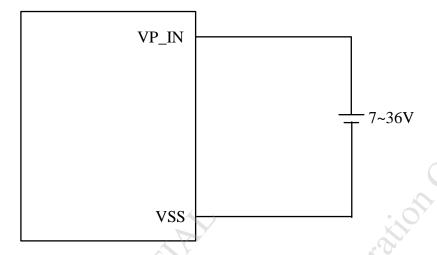
PIN NO.	SYMBOL	FUNCTION
1	GPIO1	GPIO FUNCTION PER CUSTOMER REQUEST
2	GPIO2	GPIO FUNCTION PER CUSTOMER REQUEST
3	GPIO3	GPIO FUNCTION PER CUSTOMER REQUEST
4	GPIO4	GPIO FUNCTION PER CUSTOMER REQUEST
5	GPIO5	GPIO FUNCTION PER CUSTOMER REQUEST
6	GPIO6	GPIO FUNCTION PER CUSTOMER REQUEST

# 11.9 CN9 USB INTERFACE

PIN NO.	SYMBOL	FUNCTION
1	VBUS	VBUS
2	DM	USB D -
3	DP	USB D+
4	ID	ID
5	VSS	GROUND

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# 12. POWER SUPPLY



# 13. CAPACITIVE TOUCH PANEL SPECIFICATION

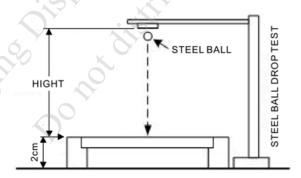
# 13.1 HARDNESS

ITEM	DESCRIPTION
SURFACE HARDNESS	7H (min)

# 13.2 DURABILITY

USING STEEL BALL AND FALLING ON TOUCH PANEL SURFACE, FROM THE HEIGHT MUST PASS BELOW CONDITIONS:

ITEM	CONDITION	INSPECTION METHOD	DESCRIPTION
STEEL BALL DROP TEST	WEIGHT: 67g HEIGHT OF FALL: 30 cm	VISUAL INSPECTION	SIGN OF FRACTURE OR DAMAGE IS NOT ACCEPTABLE 3 TIMES/ 1 POINTS, 25°C(CENTER TEST)



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### 14. INSPECTION CRITERIA

### 14.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(  $\rm E.D.T$  ) TO CUSTOMERS

MODEL NO.

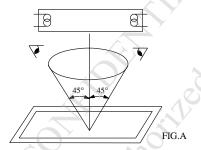
### 14.2 INSPECTION CONDITIONS

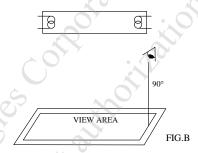
#### 14.2.1 (1)OBSERVATION DISTANCE: 45±5cm

(2) VIEWING ANGLE: ±45°

±45° (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A 90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°





THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECT TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECT TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

### 14.2.2 ENVIRONMENT CONDITIONS:

AMBIEN	25±5°C	
AMBI	$65 \pm 20\% RH$	
AMBIENT	COSMETIC INSPECTION	600~800 lux
ILLUMINATION	FUNCTIONAL INSPECTION	300~500 lux
INSP	10 secs	

# 14.2.3 INSPECTION LOT QUANTITY PER DELIVERY LOT FOR EACH MODEL

14.2.4 A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(a)APPLICABLE STANDARD:

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL: MAJOR DEFECT: AQL 0.65 MINOR DEFECT: AQL 1.0

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# 14.3 DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED     DISPLAY FUNCTION, FOR ALL     AND SPECIFIED DOTS     EX: DISCONNECTION, SHORT     CIRCUIT ETC	
MAJOR DEFECT	2.CTP FUNCTION	NO FUNCTION     BROKEN LINE     FALSE TOUCH	0.65
	3.BACKLIGHT	NO LIGHT     FLICKERING AND OTHER     ABNORMAL ILLUMINATION	
	4.DIMENSIONS	SUBJECT TO INDIVIDUAL     ACCEPTANCE SPECIFICATIONS	7
	1.DISPLAY ZONE (VIEWING AREA)	<ul> <li>BLACK/WHITE SPOT / CIRCULAR TYPE</li> <li>BUBBLES ON POLARIZER</li> <li>NEWTON RING</li> <li>BLACK/WHITE LINE / LINEAR TYPE</li> <li>SCRATCH</li> <li>CONTAMINATION</li> <li>UNEVEN COLOR SPREAD</li> </ul>	
MINOR DEFECT	2.BEZEL ZONE	<ul><li>STAINS</li><li>SCRATCHES</li><li>FOREIGN MATTER</li></ul>	1.0
	3.SOLDERING	<ul> <li>INSUFFICIENT SOLDER</li> <li>SOLDERED IN INCORRECT POSITION</li> <li>CONVEX SOLDERING SPOT</li> <li>SOLDER BALLS</li> <li>SOLDER SCRAPS</li> </ul>	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

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NO.	ITEM		CRITERIA	
1	DISPLAY ON INSPECTION	1. INCORRECT PATTERN 2. MISSING SEGMENT 3. DIM SEGMENT 4. OPERATING VOLTAGE BEYOND SPEC		
2	OVERALL DIMENSIONS	1. OVERALL DIMENSION	BEYOND SPEC	
3	DOT DEFECT	AND BLUE SCREENS.  ITEMS BRIGHT DOT DARK DOT TOTAL BRIGHT AND D.  NOTE:  (1)THE DEFINITION OF DOTHE SIZE OF A DEFECT REGARDED AS ONE DI (2)BRIGHT DOT: DOTS APPEAR BRIGHT PANEL IS DISPLAYING THE BRIGHT DOT DEFINITION.  (3)DARK DOT: DOTS APPEAR DARK A	ARK DOTS  OT: FIVE DOT OVER EFECTIVE DOT. FAND UNCHANCE UNDER BLACK ECT MUST BE VI	GED IN SIZE IN WHICH LCD
4	BUBBLES ON POLARIZER /SURFACE STAINS /DIRT/CF FAIL/SPOT	BUBBLE ON POLARIZER  SURFACE STAINS / DIRT ON POLARIZER  CF FAIL / SPOT  NOTE: (1)POLARIZER B ON ACTIVE DI BUBBLE SHAL APPEARS ON T (2)THE EXTRANI OBSERVED W (3)THE DEFINITI AS FOLLOWIN	AVERAGE DIAMI (mm): D  D ≤ 0.25  0.25 < D ≤ 0.5  0.5 < D  D < 0.25  0.25 < D ≤ 0.4  0.4 < D  D < 0.1  0.1 < D ≤ 0.3  0.3 < D  UBBLE IS DEFIN SPLAY AREA. THE L BE IGNORED INTERPRETATION OF EOUS SUBSTANCE (HEN THE MODULE) ON OF AVERAGE	PETER PERMISSIBLE NO.  IGNORE  N ≤ 5  NONE  IGNORE  N ≤ 3  NONE  IGNORE  N ≤ 3  NONE  IGNORE  N ≤ 3  NONE  ED AS THE BUBBLE APPEARS HE DEFECT OF POLARIZER FIFTHE POLARIZER BUBBLE FACTIVE DISPLAY AREA. CE IS DEFINED AS IT CAN BE ILE IS POWER ON. E DIAMETER, D IS DEFINED

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VO.	ITEM		CRITERIA	
		THE FOLLOWING BLACK/WHITE SPO		
		VIEWING AREA. AVERAGE DIAMET		
		SIZE D	PERMISSIBLE NO.	/ D
	DI ACIZAVILITE	D≤0.15	IGNORE	D / B
_	BLACK/WHITE		4	
5	SPOT CIRCULAR	0.15 <d≤0.3< td=""><td></td><td></td></d≤0.3<>		
	TYPE	0.3 <d≤0.5< td=""><td>2</td><td></td></d≤0.5<>	2	
		D>0.5	0	/
		NOTE (1): THE DISTANCE BETWE	EN DEFECTS	
		SHOULD BE MORE THA		4
		THE FOLLOWING SCRATCH IS WITH	IN THE VIEWING AREA.	1
		WIDTH: W (mm), LENGTH: L (mm)		
		SIZE W & L	PERMISSIBLE NO.	
		W≤0.05	IGNORE	
6	SCRATCH	0.05 <w≤0.08, l≤8<="" td=""><td>3</td><td></td></w≤0.08,>	3	
		0.08 <w≤0.1, l≤5<="" td=""><td>3</td><td></td></w≤0.1,>	3	
		W>0.1	0	/ W
		NOTE (1): THE DISTANCE BETWE		
		SHOULD BE MORE THA		
		THE FOLLOWING BLACK LINE, WHI		
		VIEWING AREA. WIDTH: W (mm), L		X
	BLACK /	SIZE W & L	PERMISSIBLE NO.	L -
7	WHITE LINE	W≤0.05	IGNORE	
,	LINEAR TYPE /	0.05 <w≤0.08, l≤8<="" td=""><td>3</td><td></td></w≤0.08,>	3	
	FOREIGN FIBER	0.08 <w≤0.1, l≤5<="" td=""><td>. 7 3</td><td></td></w≤0.1,>	. 7 3	
		W>0.1	0	, v
		NOTE (1): THE DISTANCE BETWE	EN DEFECTS	
		SHOULD BE MORE THA	N 5mm APART.	
		BUBBLES WITHIN VIEWING AREA.		
		AVERAGE DIAMETER : D (mm)		
		SIZE D	PERMISSIBLE NO.	
	BUBBLE / DENT	D≤0.2	IGNORE	D 🖍
8	FOR OPTICAL	0.2 <d≤0.3< td=""><td>3</td><td></td></d≤0.3<>	3	
Ü	BONDING	0.3 <d≤0.5< td=""><td>2</td><td></td></d≤0.5<>	2	
	3	D>0.5	0	/ ·
		NOTE (1): THE DISTANCE BETWE		
		SHOULD BE MORE THA		Chip of glass
		I I CORNER I	$Y \le 3mm \cdot Z \le t$	z Į.
		(f: Th	IICKNESS)	
Q	CHIPPING	(1.11	· · · · · · · · · · · · · · · · · · ·	
9	CHIPPING	FDGE X ≤ 6mm,	$Y \le 1mm, Z < t$	\ \X\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
9	CHIPPING	FDGE X ≤ 6mm,	$Y \le 1 mm$ , $Z < t$ IICKNESS)	
9	CHIPPING  CRACKED GLASS	FDGE X ≤ 6mm,	IICKNESS)	N N N N N N N N N N N N N N N N N N N
10	CRACKED GLASS	EDGE $X \le 6mm$ , $(t:TF)$ NOT ACCEPTA	BLE	***
	CRACKED GLASS LINE DEFECT	EDGE $X \le 6mm$ , $(t:TF)$	BLE	S NOT ALLOWED.
10 11	CRACKED GLASS	EDGE $X \le 6mm$ , $(t:TF)$ NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO	IICKNESS) BLE NTAL LINE DEFECT IS	
10	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY	EDGE $X \le 6mm$ , $(t:TF)$ NOT ACCEPTA	IICKNESS) BLE NTAL LINE DEFECT IS	
10 11	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR	EDGE $X \le 6mm$ , $(t:TF)$ NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO	IICKNESS) BLE NTAL LINE DEFECT IS	
10 11	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD,	EDGE $X \le 6mm$ , $(t:TF)$ NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO	IICKNESS) BLE NTAL LINE DEFECT IS LIGHT VISIBLE THRO	UGH 6% ND FILTER.
10 11 12	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR	EDGE X ≤ 6mm, (t:TH)  NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO  IT'S ACCEPTABLE, IF MURA IS S	IICKNESS) BLE NTAL LINE DEFECT IS LIGHT VISIBLE THRO	UGH 6% ND FILTER.
10 11 12	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD, COLORATION	EDGE X ≤ 6mm, (t:TH)  NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO  IT'S ACCEPTABLE, IF MURA IS S	IICKNESS) BLE NTAL LINE DEFECT IS LIGHT VISIBLE THRO ON THE LIMITED SAMI	UGH 6% ND FILTER.
10 11 12	CRACKED GLASS LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD,	EDGE  X ≤ 6mm, (t: THE NOT ACCEPTA  OBVIOUS VERTICAL OR HORIZO  IT'S ACCEPTABLE, IF MURA IS S  TO BE DETERMINED BASED UPO	BLE NTAL LINE DEFECT IS LIGHT VISIBLE THRO ON THE LIMITED SAME BE DEFORMED OR HA	UGH 6% ND FILTER.

# EMERGING DISPLAY

TECHNOLOGIES CORPORATION

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NO.	ITEM	CRITERIA
1101		1. THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE
15 P	СВ	THAN THREE PLACES.  2. NO OXIDATION OR CONTAMINATION ON PCB TERMINALS.  3. PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART.  THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS
		PARTS.  4. THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART.  5. IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD; MAKE SURE IT IS SMOOTHED DOWN.
16 S		

# EMERGING DISPLAY

ETEMB043013XDHAL

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NO.	ITEM	CRITERIA
		(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
16	SOLDERING	
		4. NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB.
		5. NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS,
		OXIDATION OR ICICLE. 6. NO RESIDUE OR SOLDER BALLS ON PCB.
		7. NO SHORT CIRCUITS IN COMPONENTS ON PCB.
		1. NO LIGHT
	BACKLIGHT	2. FLICKERING AND OTHER ABNORMAL ILLUMINATION
17		3. SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED
		USING LCD SPOT, LINES AND CONTAMINATION STANDARDS.
		4. BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
		1. NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP.
		2. NO CRACKS ON INTERFACE PIN (OLB) OF TCP.
		3. NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON
		PRODUCT.
		4. THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS.
		5. THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE
		INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE
	GENERAL APPEARANCE	INTERFACE PIN TO SEVER.  6. THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING
18		(COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO
10		BROWN OR BLACK COLOR.
		7. SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED.
		8. PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET.
		9. LCD PIN LOOSE OR MISSING PINS.
		10. PRODUCT PACKAGING MUST BE THE SAME AS SPECIFIED ON
		PACKAGING SPECIFICATION SHEET.
		11. PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO
	.67	PRODUCT SPECIFICATION SHEET.  12. THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY
		DIRT AND BREAK.

NOTE (1): FOR ANY SPOTS OR LINES, WHICH ARE NOT OBSERVED UNDER APPROPRIATE PANEL OPERATING CONDITION ARE DEEMED ACCEPTABLE.

NOTE ( 2 ) : THE FOREIGN MATERIALS THAT CAN BE BLOWN OUT BY AIR AND REMOVED BY WET CLEANING ARE NOT REGARDED AS DEFECTS.

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### 15. RELIABILITY TEST

### 15.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION		
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS		
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS		
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS		
4	LOW TEMP STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS		
5	HIGH TEMPERATURE /HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS		
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION:  +80°C  -30°C  -30°C  -30°C		
7	(ELECTROSTATIC DISCHARGE)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV ACCORDING TO IEC-61000-4-2		

NOTE ( 1 ): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION FAILURE ISSUE OCCURRED.

# 15.2 TESTING CONDITIONS AND INSPECTION CRITERIA FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 15.1, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION		THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

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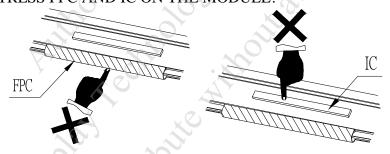
#### 16. PRECAUTION

#### 16.1 OPERATION

- 16.1.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 16.1.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 16.1.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST.
- 16.1.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.

  IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 16.1.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

  DO NOT STRESS FPC AND IC ON THE MODULE!



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#### 16.2 HANDLING

- 16.2.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGHHOLE-PAD .
- 16.2.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 16.2.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 16.2.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 16.2.5 DON'T GIVE EXTERNAL SHOCK.
- 16.2.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 16.2.7 LIQUID CRISTAL IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC.WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 16.2.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 16.2.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 16.2.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 16.2.11 REWIRING: NO MORE THAN 3 TIMES.